

Critical Current Behavior in Narrow YBa₂Cu₃O_{7-δ} Thin Films

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Critical current measurements are reported for narrow strips (down to ~1.0 μm) of YBa₂Cu₃O_{7-δ} thin films deposited and lithographically patterned by various means. A systematic increase in the critical current densities is observed in the narrowest strips, suggesting the possible presence of edge pinning in these films. The critical currents are found to be near the depairing limit for these particular films. The critical currents are found to decrease with increasing temperature near zero temperature as in the flux creep formula of Tinkham. The pinning energy derived in the flux creep regime of a 6 μm wide strip is found to be approximately 100 meV.

The critical current density J_c in thin films of the high- T_c oxide superconductors is of fundamental and technological interest. It is of particular importance to establish the mechanisms governing the magnitude of J_c . We have studied the critical currents of patterned strips of YBa₂Cu₃O_{7-δ} (YBCO) thin films as a function of the strip width in the range 1 to 13 μm. We find that high critical current densities can be retained in such narrow strips, even after lithographic patterning, and that there is a systematic increase in J_c in the narrowest strips.

Thin films of YBCO were deposited in-situ by pulsed laser ablation¹ and single target magnetron sputtering² on MgO, ZrO₂ or SrTiO₃. The oxygen pressure and substrate temperature during deposition are 200 mtorr and approximately 700 C in laser ablation, and 10 mtorr and approximately 650 C in sputter deposition, respectively. Critical currents for the films with thickness ranging from 300 Å to 2200 Å were measured on lines, typically 1-13 μm wide and 1.5 mm long, which had been patterned by standard photoresist lithography and ion milling or chemical etching using dilute nitric acid. Critical current densities were obtained by the division of the maximum zero-voltage current (dc conventional 4-terminal measurement, critical voltage = 0.4 μV (≈ 3 μV/cm)) by the

cross-sectional area of the strips.

Figure 1 shows the critical current densities of the laser ablation films on ZrO₂ as a function of temperature and strip width. The critical current density at 10 K of the 1.9 μm wide strip is approximately 1.6×10^7 A/cm², which is higher than those of the other strips by a factor of 2. The patterned strips show sharp resistive transitions with zero resistance at 87K as shown in Fig. 2. We find normal resistivities of $\rho(100K) \approx 95$ μΩ-cm and $d\rho/dT \approx 0.6$ μΩ-cm/K in these strips. The increase in the critical current is also observed in the other samples, independent of how they were deposited or patterned.

As seen from the data above, the resistive transitions of these strips are essentially independent of strip width. This indicates that no grain inhomogeneities are present in the films and that no major damage was incurred during lithographic processing. The critical currents are high and, as already noted, increase for the narrowest strips. For the wide strips, J_c is independent of strip width and presumably reflects bulk pinning. We believe the increase for the smallest width represents the affect of edge pinning (or edge barrier to vortex entry) that is expected to play a role when the width w approaches the transverse penetration depth $\lambda_{\perp} = \lambda^2/d$ where d is the film thickness.

The temperature dependence of J_c observed in the wide strips is very similar to that reported within a single YBCO grain by Mannhart, et al⁴. This suggests that the grain boundaries are not determining the critical currents in these films. Fits of our data to the flux creep expression of Tinkham³

$$J_c(t) = J_c(0) (1 - \alpha t - \beta t^2)$$

for small t yield value of $\alpha \approx 1$ and $\beta \approx 0.3$, apparently identical to the results in Ref.4. Not surprisingly the values of the pinning energy determined from the value of $\alpha = (k T/U_p) \ln E_0/E$, are also similar and of order 0.1 to 0.15 eV. Here E is the electric field criterion used to define J_c and E_0 is a characteristic electric field derived in Ref.4.

It is instructive to compare the magnitude of the observed critical current densities with the depairing value J_c^{dp} , and that expected in very narrow strips ($w < \lambda_{\perp}$) due to edge pinning J_c^{ep} . It can be shown that in magnitude (Ref.5)

$$J_c^{dp} \approx J_c^{ep} = c\Phi_0/16\pi^2\lambda^2\xi$$

Using $\lambda \approx 2500 \text{ \AA}$ as measured by our group in similar film and taking $\xi \approx 15 \text{ \AA}$, we obtain $J_c^{ep} = 1.2 \times 10^8 \text{ A/cm}^2$. In a film thickness of 800 \AA , we also obtain $\lambda_{\perp} \approx 0.75 \text{ \mu m}$, which suggests we are not yet in the $w < \lambda_{\perp}$ limit.

Nonetheless, it is evident that these films have J_c 's approaching the maximum possible values for our films. Moreover, the increase in J_c as w decrease seems related to edge pinning. Note that if we take $\lambda \approx 1500 \text{ \AA}$, as reported for the best materials, $J_c^{dp} \approx 4 \times 10^8 \text{ A/cm}^2$.

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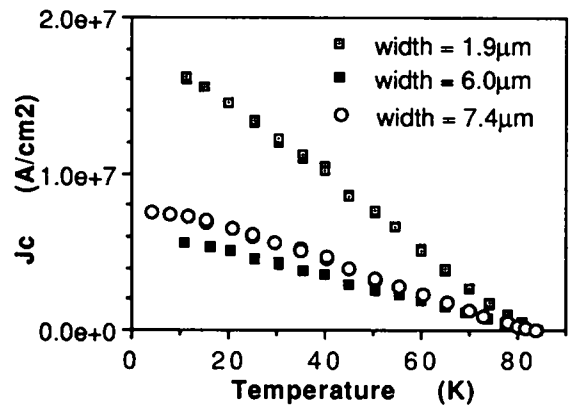


Fig.1 Temperature dependence of J_c for laser ablated films on ZrO_2 ($d = 800 \text{ \AA}$).

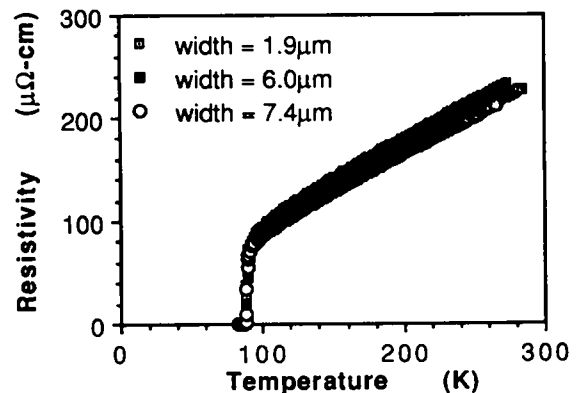


Fig. 2 Resistive transition of laser ablated films on ZrO_2 ($d = 800 \text{ \AA}$).